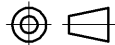




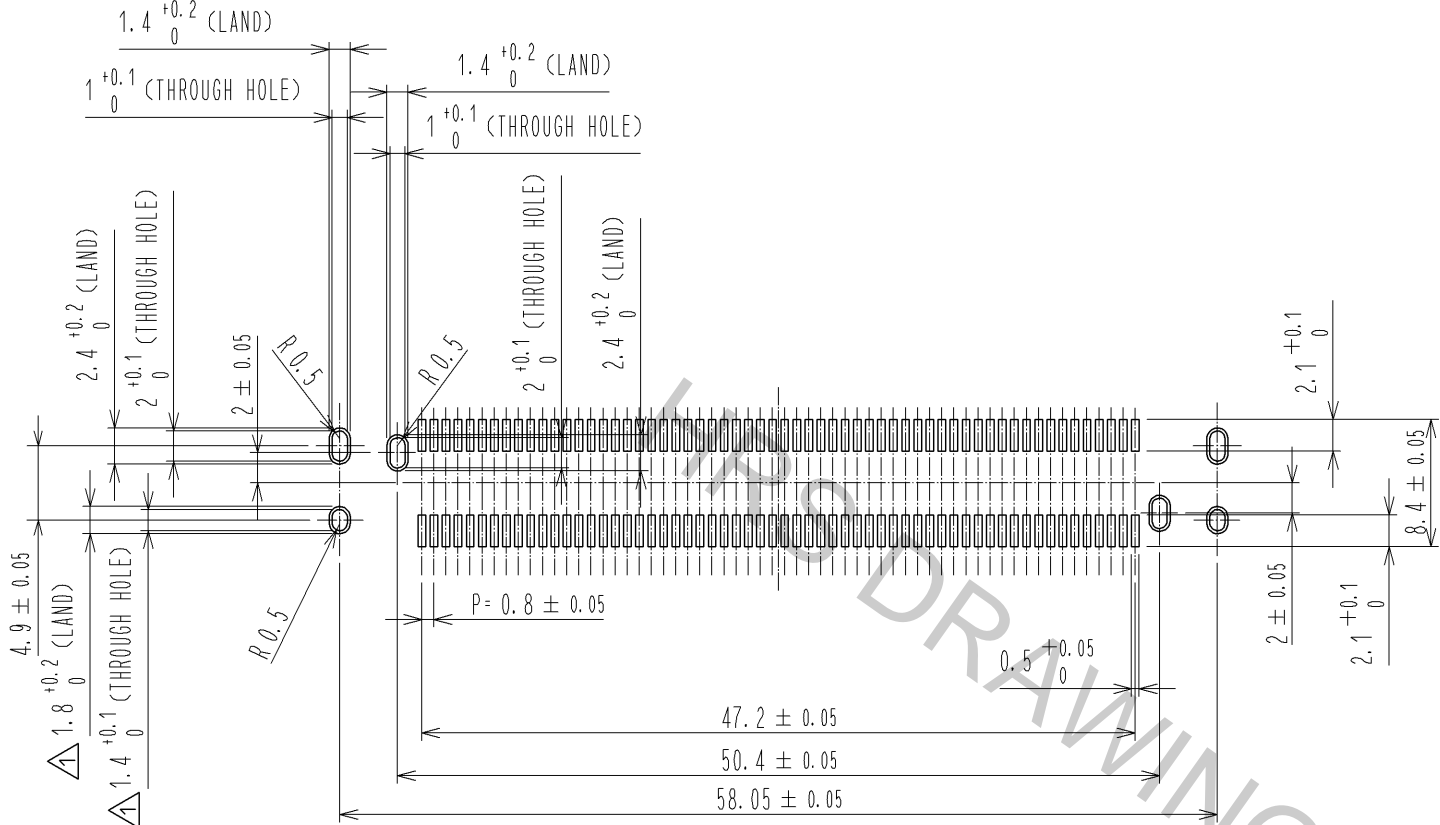


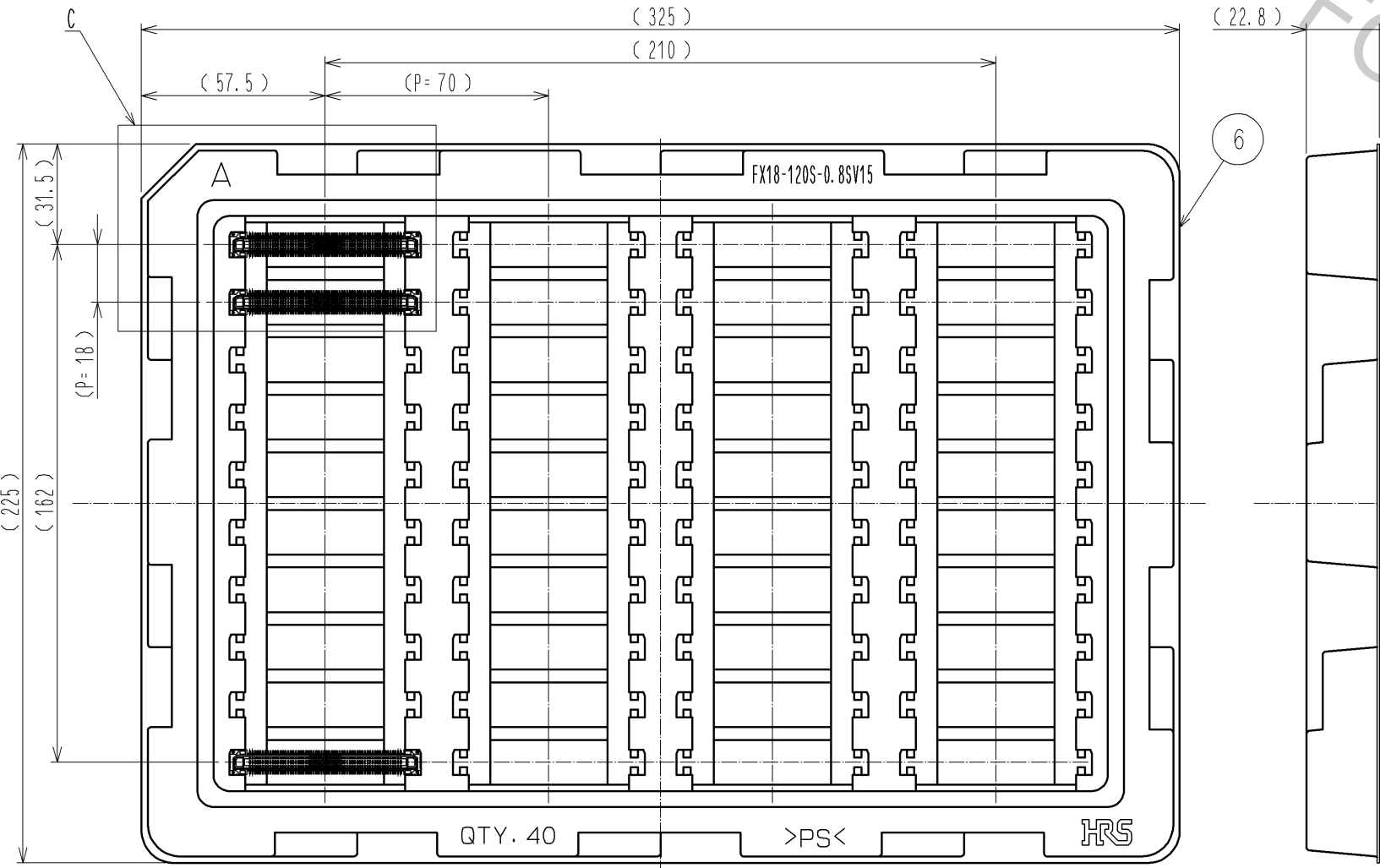
			7	POLYIMIDE					
			6	POLYSTYRENE					
3	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm	5	COPPER ALLOY	CONTACT AREA:GOLD 0.1 μm				
		LEAD AREA:GOLD 0.03 μm			LEAD AREA:TIN-PLATING 1 μm				
		UNDER PLATING:NICKEL 1.3 μm			UNDER PLATING:NICKEL 1.3 μm				
2	POLYAMIDE	BLACK UL94V-0	4	COPPER ALLOY	CONTACT AREA:GOLD 0.1 μm				
1	POLYAMIDE	BLACK UL94V-0			LEAD AREA:TIN-PLATING 1 μm				
					UNDER PLATING:NICKEL 1.3 μm				
NO.		MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS		
UNITS mm			SCALE 2 : 1	COUNT  4	DESCRIPTION OF REVISIONS DIS-F-005578		DESIGNED TH. SANO	CHECKED KI. HIROKAWA	DATE 11. 07. 21
 HIROSE ELECTRIC CO., LTD.			APPROVED : HS. OKAWA	11. 03. 17	DRAWING NO.	EDC3-334389-00			
			CHECKED : KI. HIROKAWA	11. 03. 17	PART NO.	FX18-120S-0.8SV15			
			DESIGNED : TH. SANO	11. 03. 17	CODE NO.	CL579-0029-1-00			
			DRAWN : TH. SANO	11. 03. 17				 1	 2

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In case that the application demands a high level of reliability, such as automotive,  
please contact a company representative for further information.

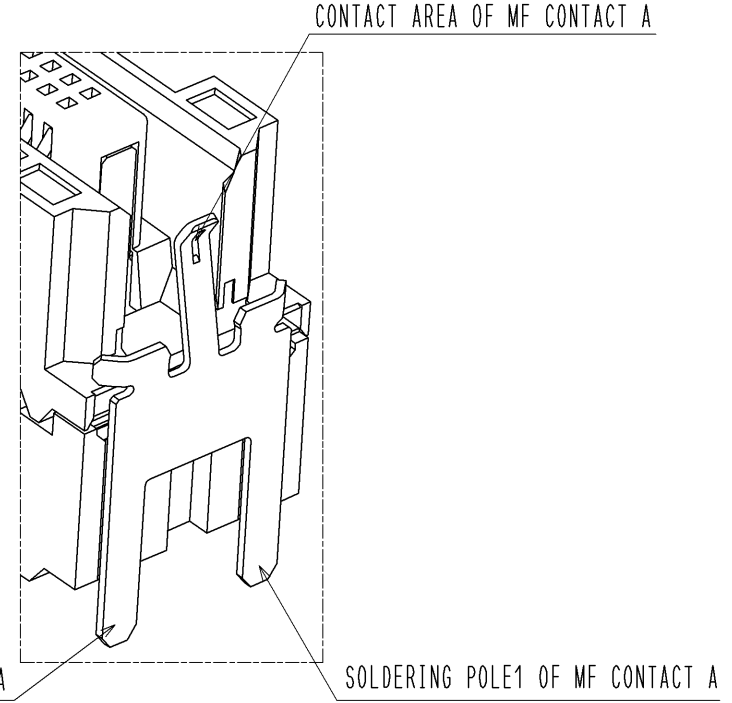
RECOMMENDED LAND PATTERN DIMENSION OF PCB(2:1)  
(PCB THICKNESS:t=1.6mm METAL MASK THICKNESS:t=0.12mm)



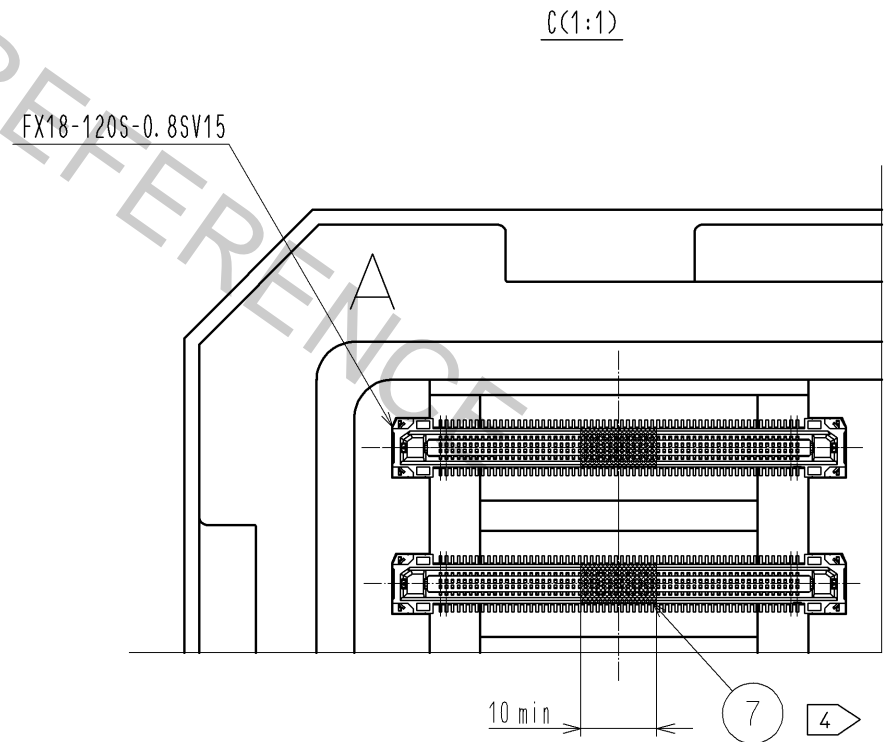
5 DRAWING FOR PACKING(1:2)



8 CONFIGURATION OF MF CONTACT A



NOTE 8 SOLDERING LEAD OF MF CONTACT A SPLITS INTO TWO POLES.  
BE SURE TO CONNECT TO THE SAME CIRCUIT.



HRS	DRAWING NO.	EDC3-334389-00
	PART NO.	FX18-120S-0.8SV15
	CODE NO.	CL579-0029-1-00